

A

B

C

D

E

F

G

A

B

C

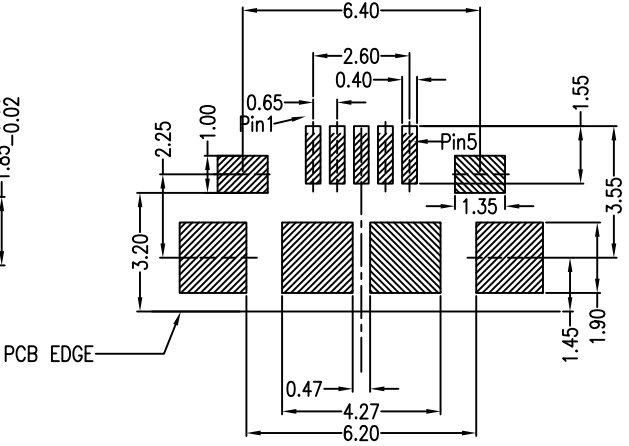
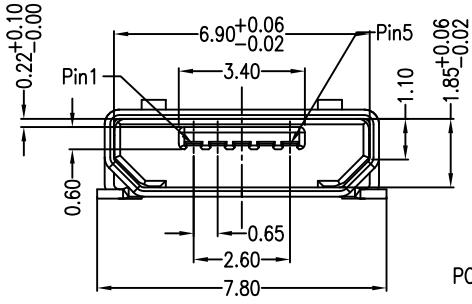
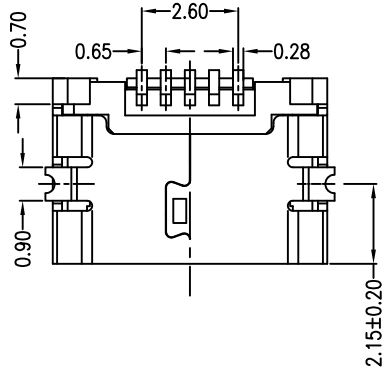
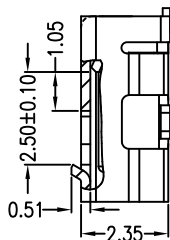
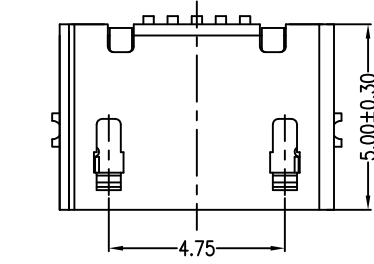
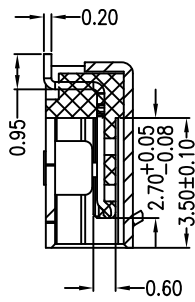
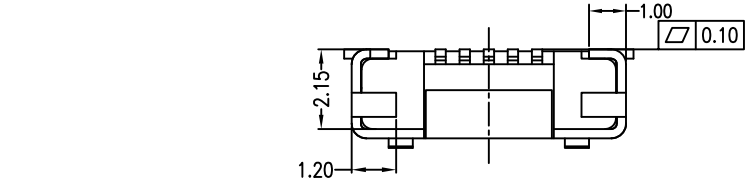
D

E

F

G

MAPX	MODIFICATION	DATE



- Note:
- 1.Material:
- 1.1 Housing: High temperature thermoplastic with g.f,UL94v-0
 - 1.2 Contact: copper alloy,t=0.20mm
 - 1.3 Shell: copper or sus304,t=0.25mm
- 2.Specification:
- 2.1 Current rating:1,5PIN 1.8A Max/2,3,4PIN 1A Max.
 - 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
 - 2.3 Contact resistance: 30 mΩ Max.
 - 2.4 Insulation resistance: 100 MΩ Min.
 - 2.5 Total mating force: 3.57 Kgf Max.
 - 2.6 Total unmating force: 1.0 Kgf Min
 - 2.7 Temperature range: -30°C~80°C

产品图 PRODUCT CHART DWG		深圳市精拓金电子有限公司							
公差一览表 TOLERANCE UNLESS OTHERWISE		单位 UNITS	MM	制图 DRAWING	尹先华	制图料号 PRODUCT PART NO.	920-D62A2021S10104		
X	±0.30	X	±5.°	比例 SCALE	郭治富	产品名称 PRODUCT_NA	MICRO 5P B型两脚贴板无边无柱加焊脚 SMT加长0.2		
.X	±0.25	.X	±2.°	日期 DATE	2021-04-16	角法 VIEW	版本 VER	AO	
.XX	±0.15	.XX	±1.°						
.XXX	±0.10	.XXX	±0.5°						